

JOC301XD5 Series

Rev.A.1.0

DESCRIPTION:

The JOC301XD5 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon random-phase photo triac in a plastic DIP5 package with different lead forming options. With the robust coplanar double mold structure, JOC301XD5 series provide the most stable isolation feature. The products are widely used in solenoid/valve controls, lighting controls, motor controls, temperature controls, static AC power switches, solid state relays, interfacing microprocessors up to 120 V_{AC} peripherals.

MAIN FEATURES

High isolation 5000 VRMS

DC input with random-phase photo triac output

Operating temperature range -55 °C to 100 °C

REACH & RoHS compliance

HBM: H3A ; MM: M4

CQC approved

VDE approved

UL approved



ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	I _F	60	mA
	Reverse Voltage	V _R	6	V
	Junction Temperature	T _j	125	°C
	Input Power Dissipation	P _I	100	mW
	Power Dissipation Derating (T _a ≥ 25°C)	Δ P _D /°C	-1.33	mW/°C
Output	Off-state Output Terminal Voltage	V _{OFF}	250	V
	Peak On-state Current (100μs pulse, 120 pps)	I _{TP}	2	A
	On-state RMS Current	I _{T(RMS)}	100	mA
	Peak Repetitive Surge Current (P _W =10 ms)	I _{TSM}	1	A

	Junction Temperature	T_j	125	°C
	Output Power Dissipation	P_O	250	mW
	Power Dissipation Derating ($T_a \geq 25^\circ\text{C}$)	$\Delta P_D/^\circ\text{C}$	-3.33	mW/°C
Total Power Dissipation		P_{tot}	350	mW
Isolation Voltage		V_{iso}	5000 ^①	V _{rms}
Operating Temperature		T_{opr}	-55~100	°C
Storage Temperature		T_{stg}	-55~125	°C
Soldering Temperature		T_{sol}	260 ^②	°C

NOTE1: AC for 1minute, R.H.=40~60%

NOTE2: For 10 seconds

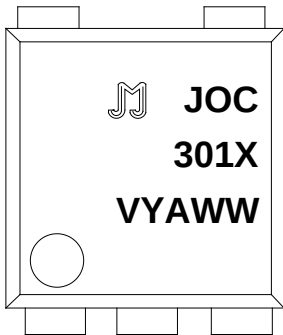
ELECTRICAL CHARACTERISTICS (Temperature=25°C)

Parameter			Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage		V_F	$I_F=10\text{mA}$	-	1.24	1.4	V
	Reverse Current		I_R	$V_R=6\text{V}$	-	-	1	μA
	Input Capacitance		C_{in}	$V=0, f=1\text{kHz}$	-	10	-	pF
Output	Peak Off-state Current, Either Direction		I_{OFF}	$V_{\text{OFF}}=250\text{V}, I_F=0$	-	-	100 ^③	nA
	Peak On-state Voltage, Either Direction		V_{TM}	$I_{\text{TM}}=100\text{mA}$	-	1.8	2.5	V
	Critical Rate of Rise of Off-state voltage		dV/dt	$V_{\text{PEAK}}=250\text{V}, I_F=0$	1000 ^④	-	-	V/μs
Transfer Characteristics	LED Trigger Current	JOC3010D5	I_{FT}	Terminal Voltage=3V $I_{\text{TM}}=100\text{mA}$	-	-	15	mA
		JOC3011D5			-	-	10	
		JOC3012D5			-	-	5	
	Holding Current		I_H	$I_{\text{TM}}=2\text{mA}, I_F=\text{Rated } I_{\text{FT}}$	-	250	-	μA
	Isolation Resistance		R_{ISO}	DC500V 40~60%R.H.	10^{12}	10^{14}	-	Ω
	Floating Capacitance		C_{IO}	$V=0, f=1\text{MHz}$	-	5	-	pF
	Response Time		t_{on}	$V_D=6\text{V}, R_L=100\Omega, I_F=20\text{mA}$	-	15	50	μs

NOTE3: Test voltage must be applied within dV/dt ratings.

NOTE4: Refer to Fig.14 & Fig.15

ORDERING AND MARKING INFORMATION

MARKING INFORMATION			
		JOC : Company Abbr. 301X : Part Number & Rank V : VDE Option Y : Fiscal Year A : Manufacturing Code WW : Work Week	
ORDERING INFORMATION			
JOC301XD5(Y)(Z)-GV			
JOC – Company Abbr. 301X – Part Number (0/1/2) D5 – DIP5 Package Y – Lead Form Option (M/SL/None) Z – Tape and Reel Option (T1) G – Green Option (G or None) V – VDE Option (V or None)			
Packing Quantity			
Option	Quantity	Quantity – Inner box	Quantity –Outer box
None	65 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box =20.8k Units
M	65 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box =20.8k Units
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box =15k Units

Characteristics Curves

FIG.1: Forward Current vs. Ambient Temperature

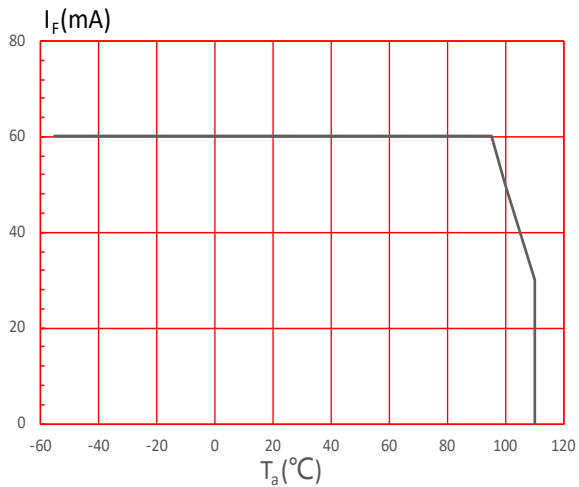


FIG.2: On-state Terminal Current vs. Ambient Temperature

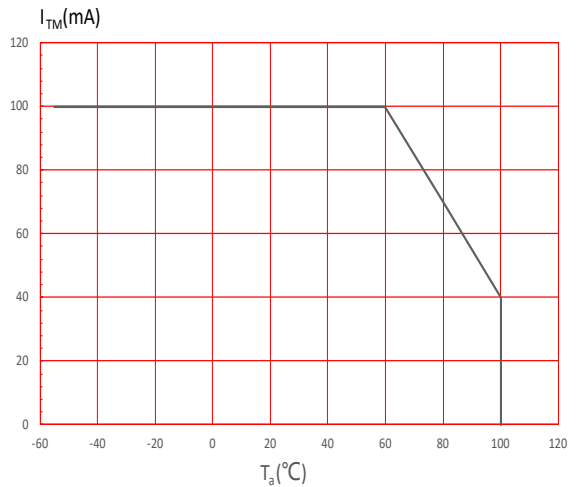


FIG.3: Forward Current vs. Forward Voltage

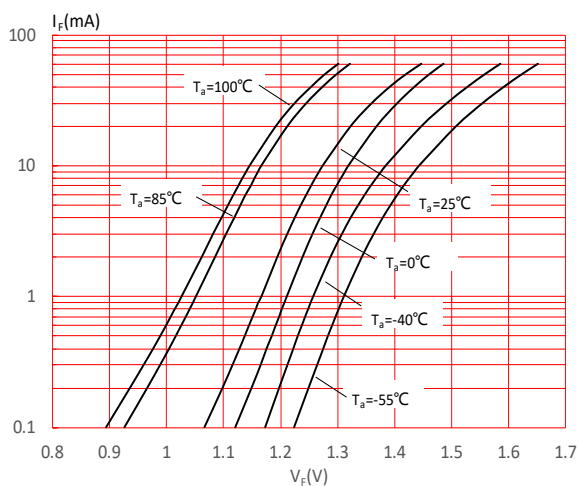


FIG.4: Normalized Off-state Terminal Current vs. Ambient Temperature

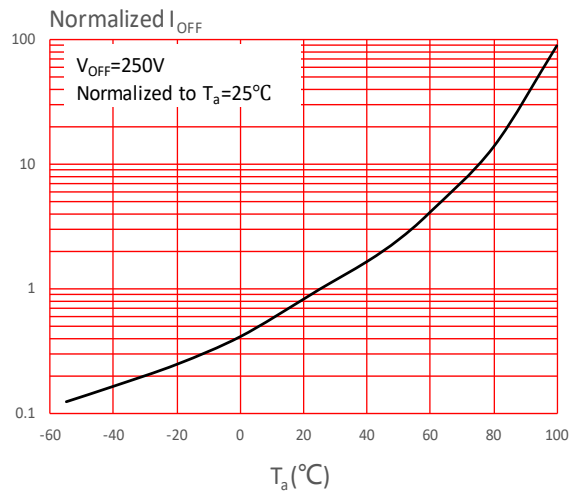


FIG.5: Normalized Off-state Terminal Voltage vs. Ambient Temperature

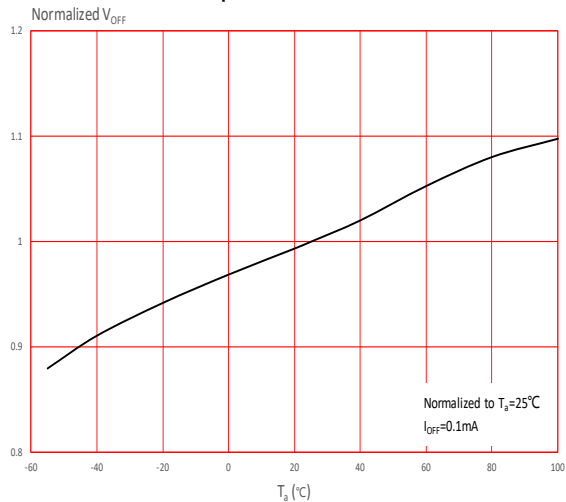


FIG.6: Normalized Trigger Current vs. Ambient Temperature

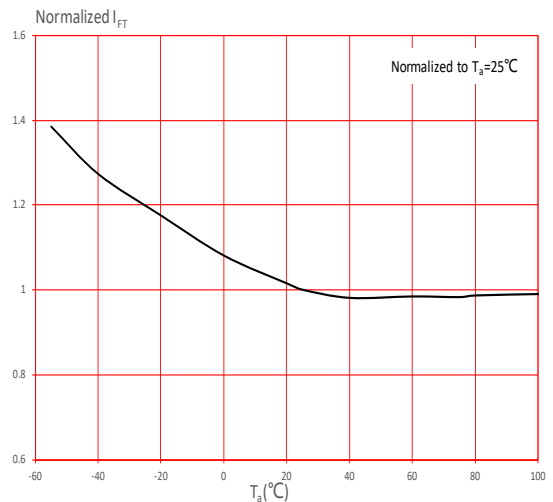
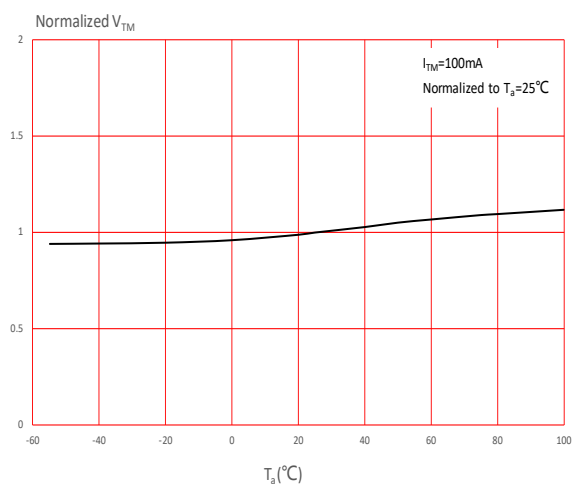
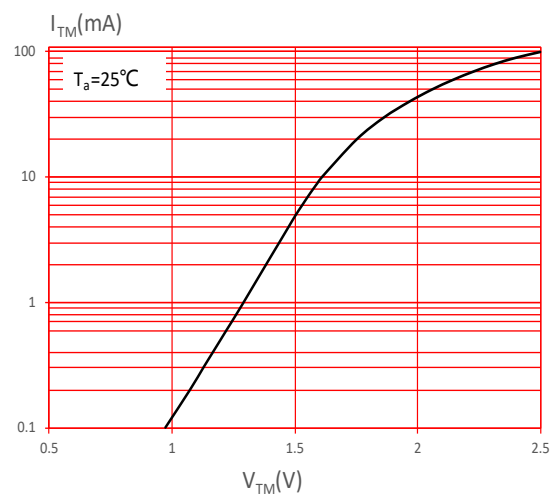
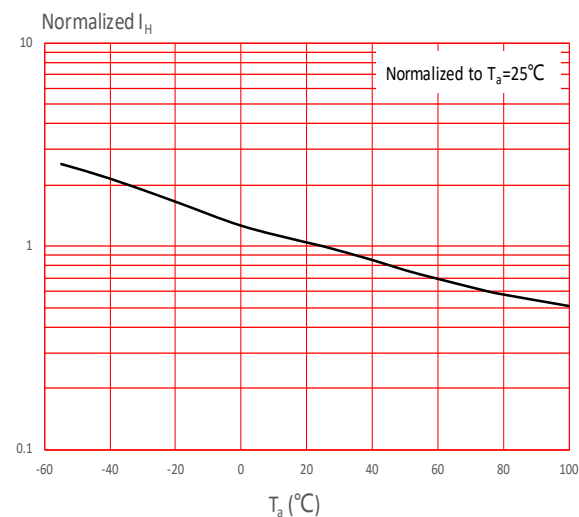
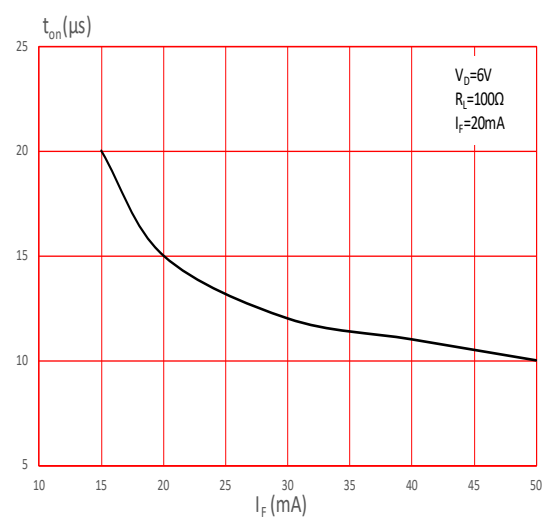
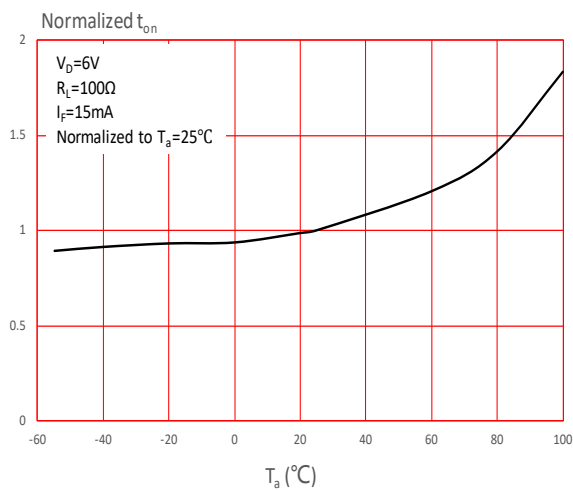


FIG.7: Normalized On-state Terminal Voltage vs. Ambient Temperature

FIG.8: On-state Terminal Voltage vs. On-state Terminal Current

FIG.9: Normalized Holding Current vs. Ambient Temperature

FIG.10: Turn On Time vs. Forward Current

FIG.11: Normalized Turn On Time vs. Ambient Temperature


TEST CIRCUITS

FIG.12: Test Circuits of Turn On Time

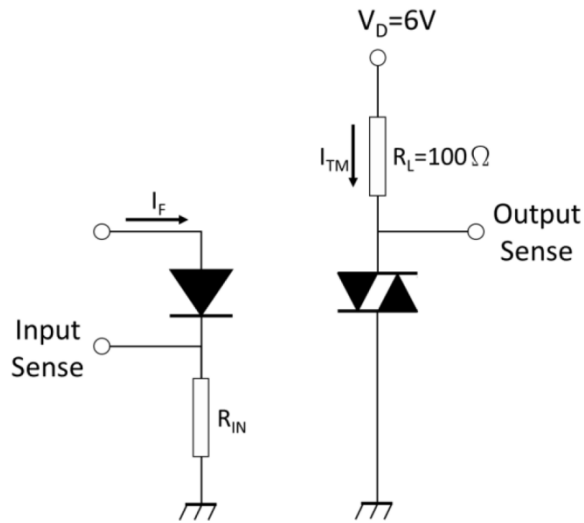


FIG.13: Waveforms of Turn On Time

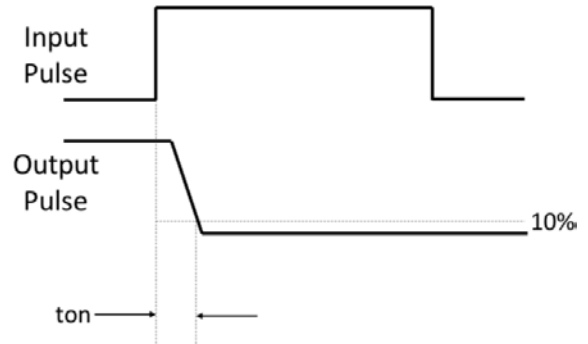


Fig.14: Test Circuits of dV/dt

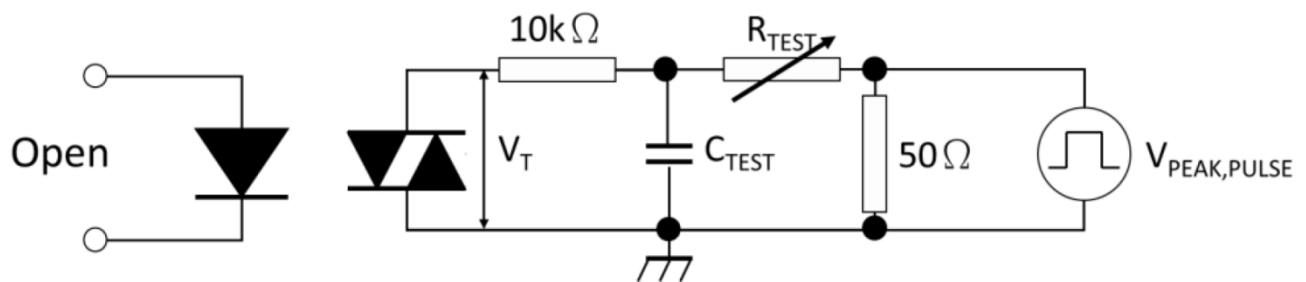
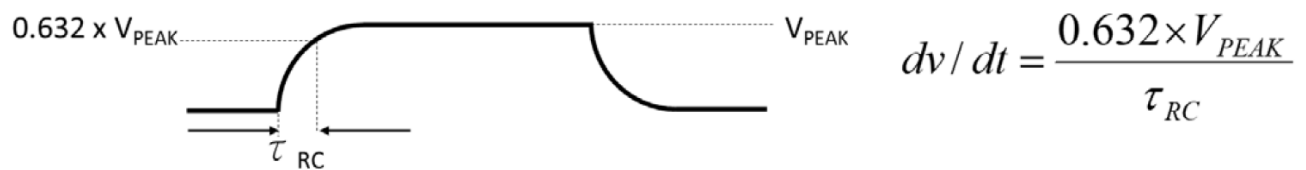
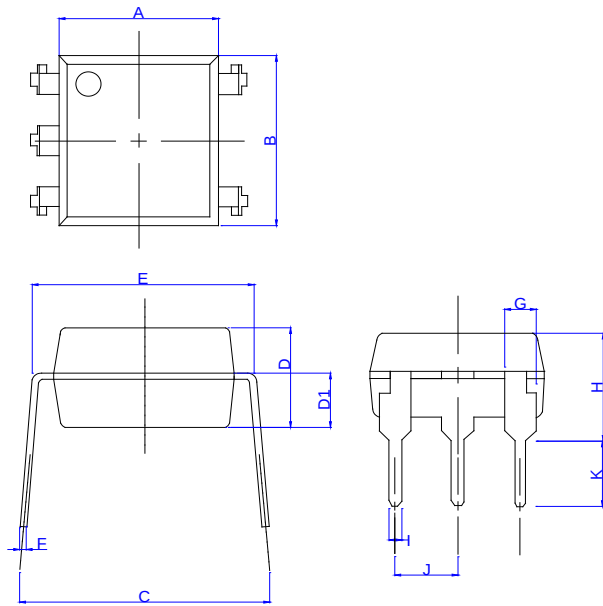


Fig.15: Waveforms of dV/dt



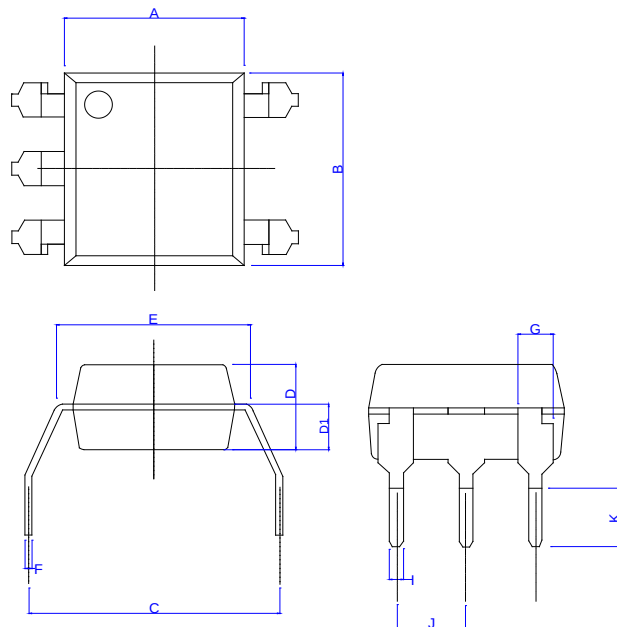
Package Dimension (Unit: mm)

Standard DIP Type:



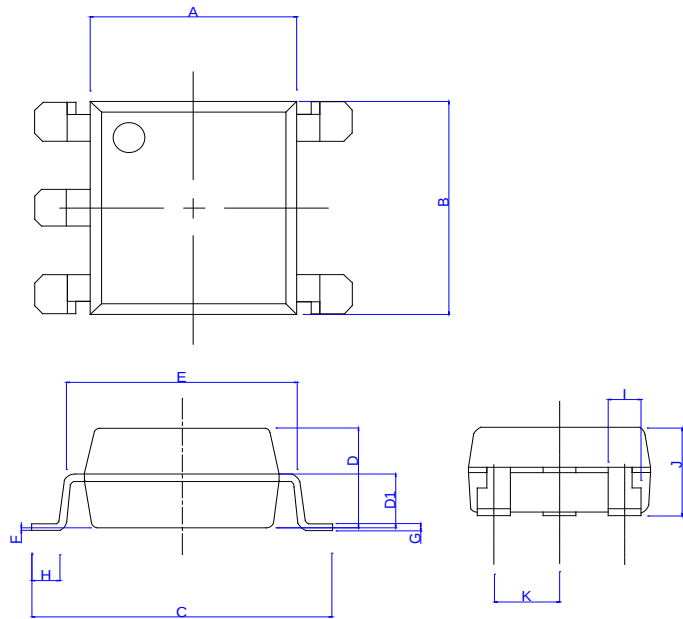
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.00		7.00	0.237		0.277
B	6.62		7.62	0.262		0.301
C	7.62		10.16	0.301		0.402
D	3.00		4.00	0.119		0.158
D1	1.55		1.95	0.061		0.077
E	7.32		7.92	0.289		0.313
F	0.16		0.36	0.006		0.014
G	0.90		1.50	0.036		0.059
H	3.50		4.50	0.138		0.178
I	0.40		0.60	0.016		0.024
J	2.29		2.79	0.091		0.110
K	2.40		3.40	0.095		0.134

Option M Type:



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.00		7.00	0.237		0.277
B	6.82		7.42	0.270		0.293
C	9.66		10.66	0.382		0.421
D	3.00		4.00	0.119		0.158
D1	1.55		1.95	0.061		0.077
E	7.32		7.92	0.289		0.313
F	0.16		0.36	0.006		0.014
G	0.90		1.50	0.036		0.059
I	0.40		0.60	0.016		0.024
J	2.29		2.79	0.091		0.110
K	2.50			0.099		

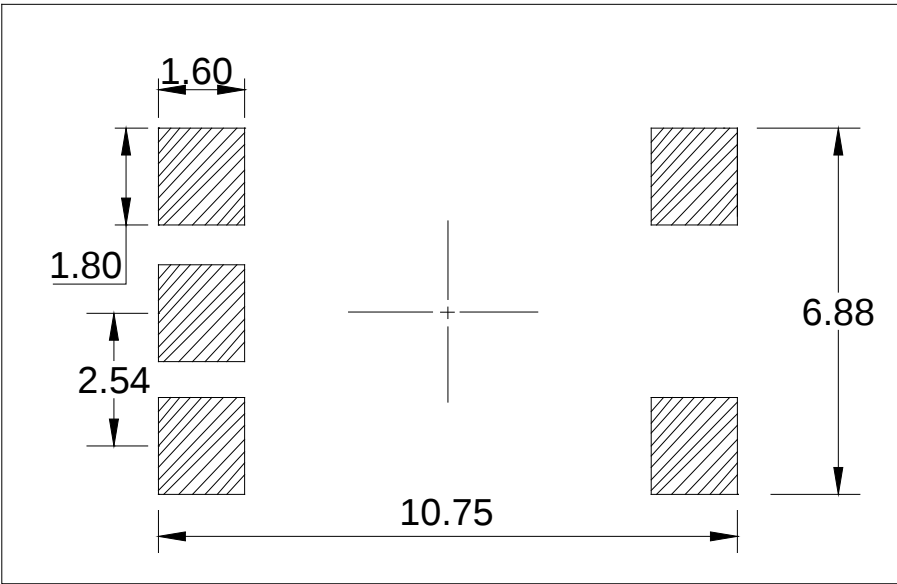
Option SL Type:



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	6.00		7.00	0.237		0.277
B	6.62		7.62	0.262		0.301
C	9.50		10.00	0.375		0.395
D	3.00		4.00	0.119		0.158
D1	1.55		1.95	0.061		0.077
E	7.32		7.92	0.289		0.313
F	0.10		0.65	0.004		0.026
G	0.16		0.36	0.006		0.014
H	1.00		1.40	0.047		0.055
I	0.90		1.50	0.036		0.059
J	3.35		4.35	0.132		0.172
K	2.29		2.79	0.091		0.110

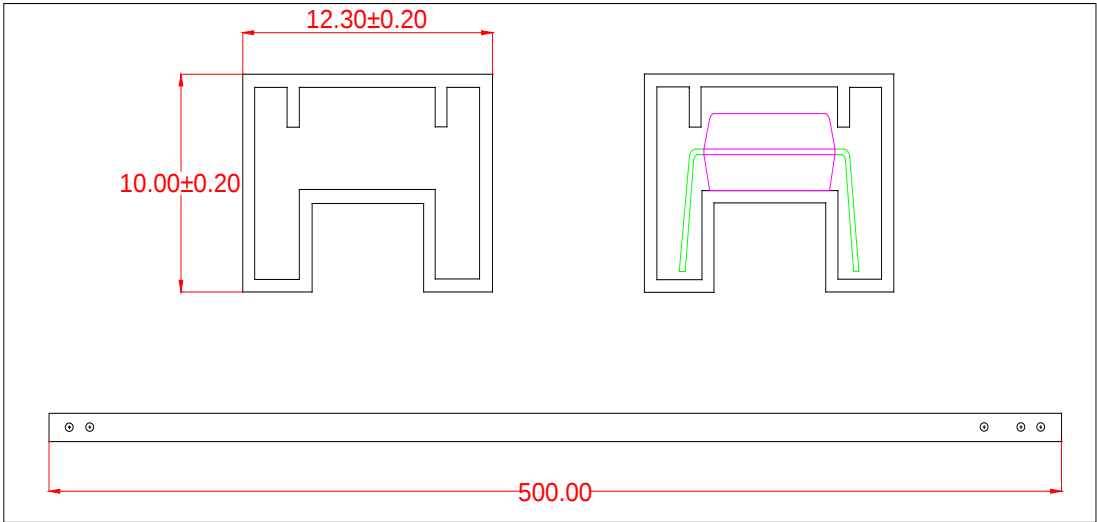
RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

Option SL

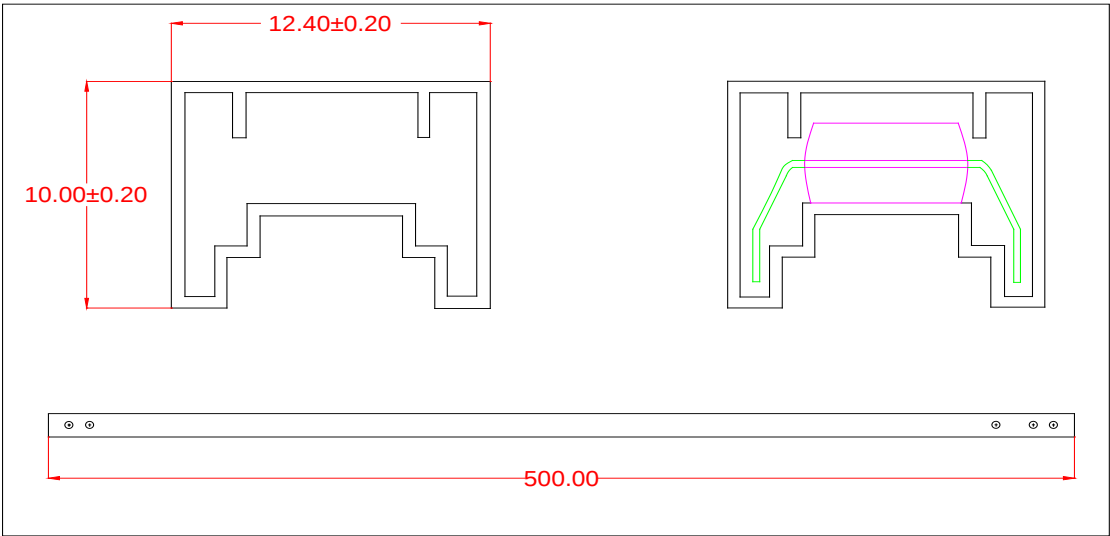


TUBE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Standard DIP

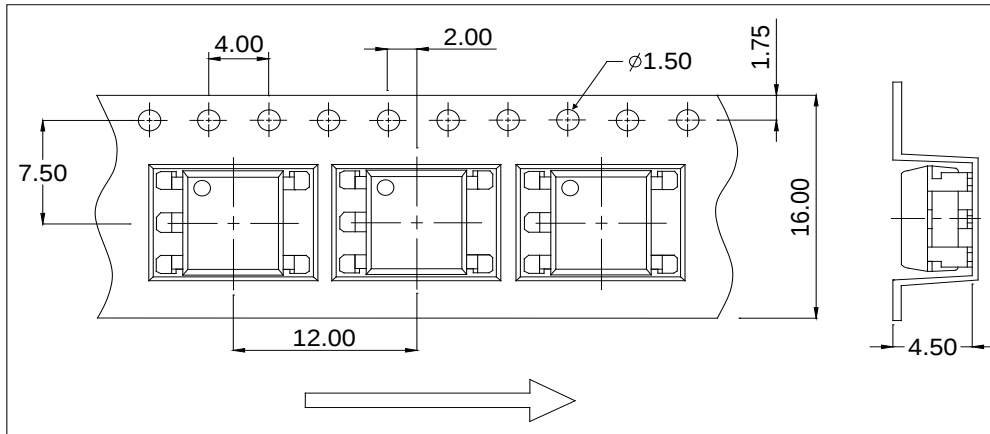


Option M

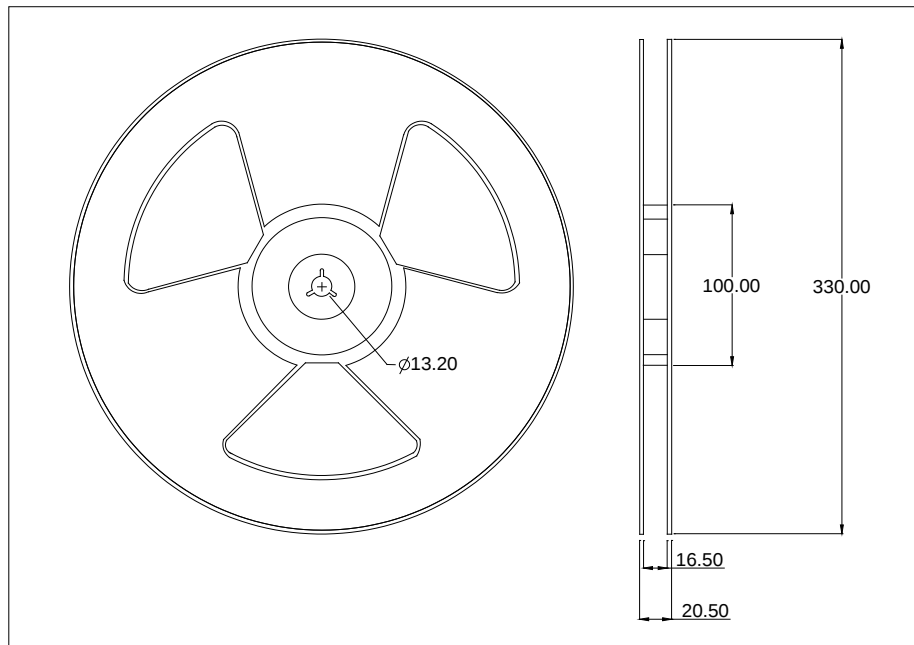


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

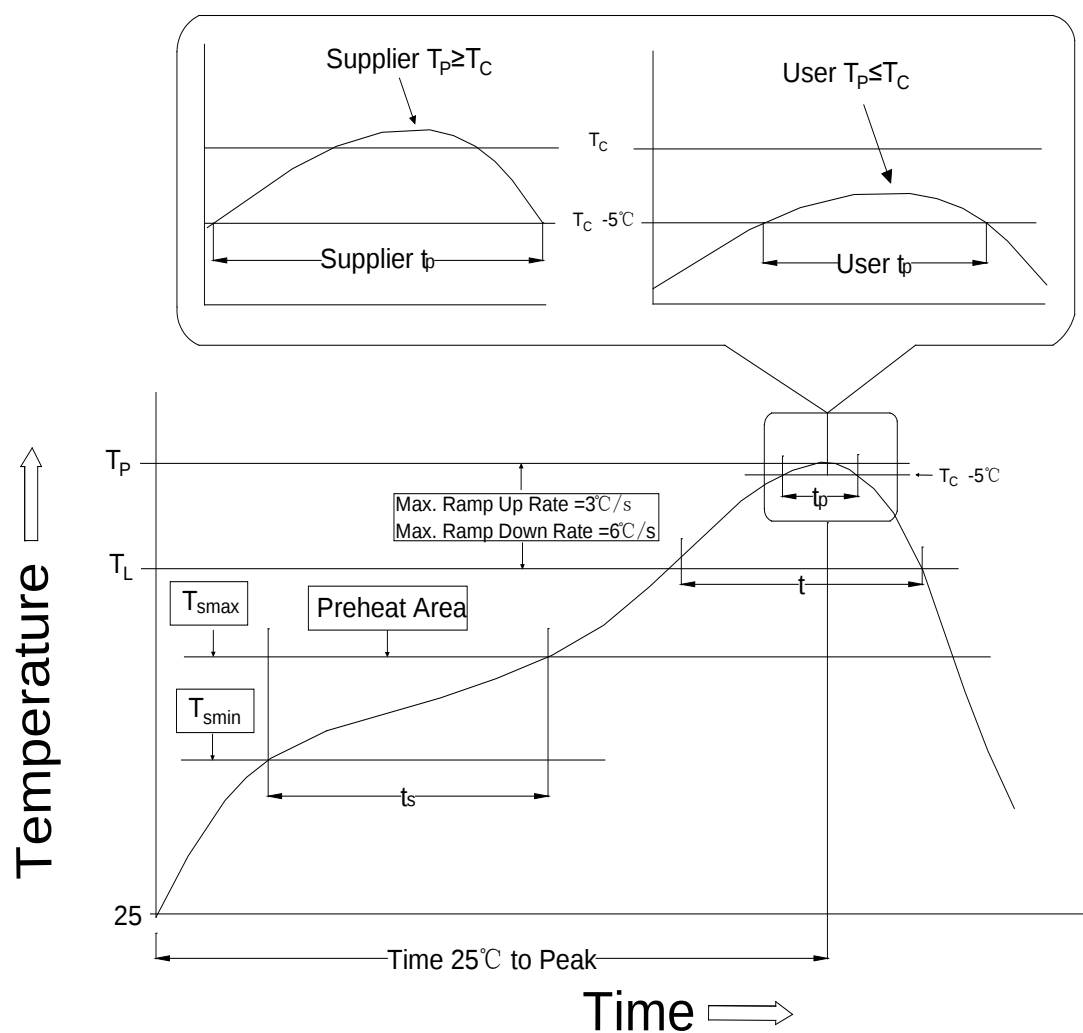
Option SL(T1)

**REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)**

Option SL

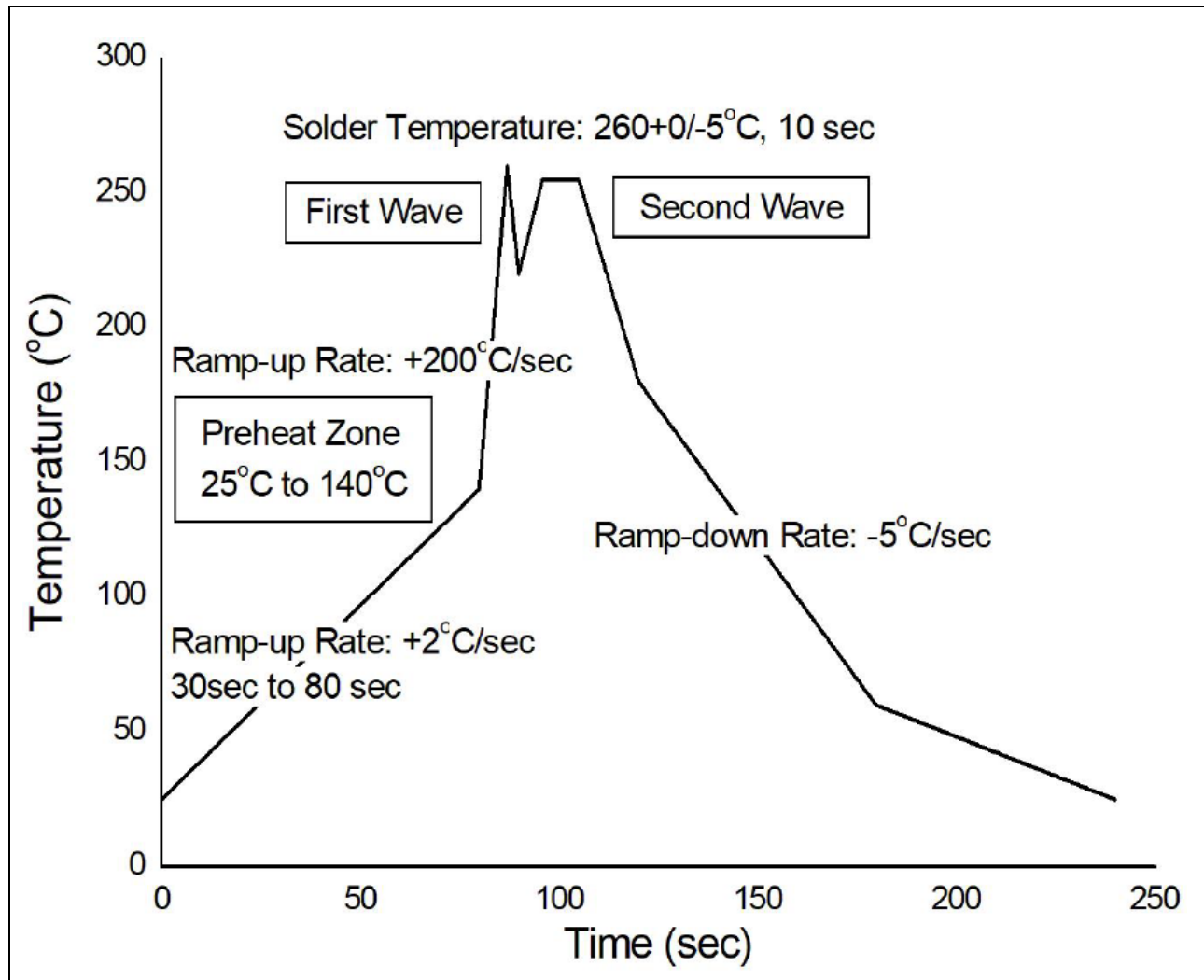


REFLOW INFORMATION



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T_{smin})	100	150°C
Temperature Max. (T_{smax})	150	200°C
Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t_L to T_P)	3°C/second max.	3°C/second max.
Liquidus Temperature (T_L)	183°C	217°C
Time (t_L) Maintained Above (T_L)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235°C+0°C/-5°C	260°C+0°C/-5°C
Time (t_P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

WAVE SOLDERING



HAND SOLDERING BY SOLDERING IRON

Soldering Temperature	360±5°C
Soldering Time	3s max.

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